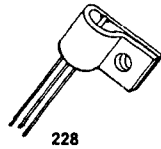




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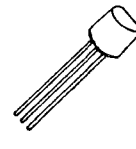


195.1

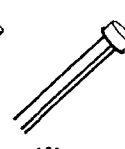


228

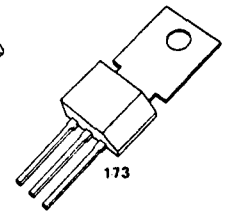
PHASE CONTROL SCR's .5 TO 5 AMPERES



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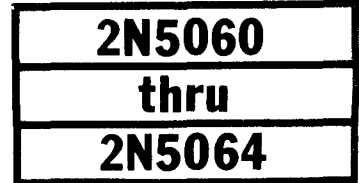
GE TYPE	C3	C103	C203	C5	C6	C7	—	C106	C107	C108
JEDEC	2N877-81 ⁽¹⁾	—	2N5060-64	2N2322-29	—	2N2344-48	2N1595-99, A	—	—	—
ELECTRICAL SPECIFICATIONS										
VOLTAGE RANGE	30-200	30-200	30-400	25-400	25-400	25-200	50-400	15-600	15-600	15-600
FORWARD CONDUCTION										
$I_{T(RMS)}$	Max. RMS on-state current (A)									
	0.5	0.8	0.8	1.6	1.6	1.6	1.6	4.0	4.0	5.0
$I_{T(AV)}$	Max. average on-state current @ 180° conduction (A) @ T_C									
	0.32 @ 85°C	0.50 @ 25°C	0.50 @ 25°C	1.0 @ 85°C	1.0 @ 85°C	1.0 @ 55°C	1.0 @ 110°C	2.5 @ 30°C	2.5 @ 20°C	3.75 @ 30°C
I_{TSM}	Max. peak one cycle, non-repetitive surge current (A)									
	7	8	8	15	10	15	15	20	15	30
I^2t	Max. I^2t for fusing for > 1.5 msec (A ² sec)									
	—	—	—	0.5	0.5	—	0.5	0.5	0.5	1
V_{TM}	Max. peak on-state voltage @ 25°C, 180° conduction, rated $I_{T(AV)}$ (V)									
	1.6	1.5	1.5	2.2	1.4	2	2	2.2	2.5	1.35
$R_{\theta JC}$	Max. internal thermal resistance, dc junction-to-case (°C/W)									
	80	125	75	10	10	—	—	10	10	10
I_H	Max. holding current @ 25°C (mA)									
	5	5	5	2	5	1	—	3	6	3
t_q	Typical turn-off time (μsec) @ max. T_J									
	15	15	15	40	40	20	40	40	40	40
	Maximum turn-off time (μsec @ 110°C)									
	—	—	—	—	—	—	—	100	100	100
$t_d + t_r$	Typical turn-on time (μsec @ 110°C)									
	1	1.4	1.4	1.4	1.4	1.4	1.2	1	1	1
di/dt	Max. rate-of-rise of turned-on current (A/μsec)									
	—	—	—	50	—	—	—	50	50	50
T_J	Junction operating temperature range (°C)									
	-65 to 125	-65 to 125	-65 to 125	-65 to 125	-40 to 125	-65 to 100	-65 to 150	-40 to 110	-40 to 110	-40 to 110
BLOCKING										
dv/dt	Typical critical rate-of-rise of off-state voltage, exponential to rated V_{DRM} @ max. rated T_J (V/μsec)									
	40	20	20	20	20	20	20	8	8	8
FIRING										
I_{GT}	Max. required gate current to trigger (μA)									
	300 @ -65°C	500 @ -40°C	500 @ 25°C	350 @ 25°C	— @ 25°C	75 @ 25°C	— @ 25°C	— @ 25°C	— @ 25°C	— @ 25°C
V_{GT}	Max. required gate voltage to trigger (V)									
	200 @ -65°C	200 @ -40°C	200 @ 25°C	200 @ 25°C	1000 @ 25°C	20 @ 25°C	10,000 @ 25°C	200 @ 25°C	500 @ 25°C	200 @ 25°C
V_{GT}	Min. required gate voltage to trigger (V)									
	0.8 @ 110°C	0.8 @ 110°C	0.8 @ 110°C	0.8 @ 110°C	0.8 @ 110°C	0.8 @ 110°C	3 @ 110°C	0.8 @ 110°C	0.8 @ 110°C	0.8 @ 110°C
	0.05 @ 125°C	0.1 @ 125°C	0.1 @ 125°C	0.1 @ 125°C	0.1 @ 125°C	— @ 125°C	— @ 125°C	— @ 125°C	— @ 125°C	— @ 125°C
VOLTAGE TYPES										
Repetitive Peak Forward and Reverse Voltages										
15	—	—	—	—	—	—	—	C106Q1	C107Q1	C108Q1
25	—	—	—	2N2322 C5U	C6U	2N2344	—	—	—	—
30	2N877	C103Y	2N5060 C203Y	—	—	—	—	C106Y1	C107Y1	C108Y1
50	—	—	—	2N2323* C5F	C6F	2N2345	2N1595, A	C106F1	C107F1	C108F1
60	2N878	C103YY	2N5061 C203YY	—	—	—	—	—	—	—
100	2N879	C103A	2N5062 C203A	2N2324* C5A	C6A	2N2346	2N1596, A	C106A1	C107A1	C108A1
150	2N890	—	2N5063	2N2325 C5G	C6G	2N2347	—	—	—	—
200	2N881	C103B	2N5064 C203B	2N2326* C5B	C6B	2N2348	2N1597, A	C106B1	C107B1	C108B1
250	—	—	—	2N2327 C5H	—	—	—	—	—	—
300	—	—	C203C	2N2328* C5C	C6C	—	2N1598, A	C106C1	C107C1	C108C1
400	—	—	C203D	2N2329* C5D	C6D	—	2N1599, A	C106D1	C107D1	C108D1
500	—	—	—	—	—	—	—	C106E1	C107E1	C108E1
600	—	—	—	—	—	—	—	C106M1	C107M1	C108M1
PACKAGE OUTLINE NO.	112	195.1, 228	263	101	101	101	101	173	173	173

* JAN & JANTX types available.

1. 2N885-89 available 20 mA max. I_{GT} .2. 2N2322A-28A available 20 mA max. I_{GT} .

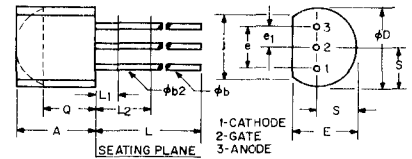
Silicon Controlled Rectifier

0.8A RMS UP TO 200 VOLTS



TYPICAL APPLICATIONS:

- Sensors
 - Temperature
 - Pressure
 - Dryness
 - Proximity
 - Voltage
 - Current
- Amplifiers (gate)
- Timers
- Logic Circuits
- Controls
 - Small Motors
 - Small Lamps
 - Remote
- Switching
 - Solid-State Relay
 - Relay Driver
 - Counter
 - Low Power Inverter
- 120V AC Line Operation



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	.170	.210	4.58	5.33	
phi b	.016	.021	.407	.533	1, 3
phi b2	.016	.019	.407	.482	3
phi D	.175	.205	4.96	5.20	
E	.125	.165	3.94	4.19	
a	.095	.105	2.42	2.66	
*1	.045	.055	1.15	1.39	
J	.135	—	3.43	—	
L	.500	—	12.70	—	1, 3
L1	—	.050	—	1.27	3
L2	.250	—	6.35	—	3
Q	.115	—	2.93	—	2
S	.080	.105	2.42	2.66	

NOTES:
 1. THREE LEADS.
 2. CONTOUR OF THE PACKAGE BEYOND THIS ZONE IS UNCONTROLLED.
 3. (THREE LEADS) phi b2 APPLIES BETWEEN L1 AND L2. phi b APPLIES BETWEEN L2 AND .5 INCH (12.70 MM) FROM SEATING PLANE. DIAMETER IS UNCONTROLLED IN L1 AND BEYOND .5 INCH (12.70 MM) FROM SEATING PLANE.

FEATURES:

- 200 μ A Gate Sensitivity
- 6-Amp Surge
- 30 through 200 Volt Selection
- Plastic TO-92 Package
- Low V_F
- High dv/dt

MAXIMUM ALLOWABLE RATINGS

TYPE	REPETITIVE PEAK OFF-STATE VOLTAGE, $V_{DRM}^{(1)}$ $T_C = -65^\circ\text{C to } +125^\circ\text{C}$	REPETITIVE PEAK REVERSE VOLTAGE, $V_{DRM}^{(2)}$ $T_C = -65^\circ\text{C to } +125^\circ\text{C}$	NON-REPETITIVE PEAK REVERSE VOLTAGE, $V_{BSM}^{(2,3)}$ $T_C = -65^\circ\text{C to } +125^\circ\text{C}$
2N5060	30 Volts*	30 Volts*	45 Volts*
2N5061	60 Volts*	60 Volts*	80 Volts*
2N5062	100 Volts*	100 Volts*	125 Volts*
2N5063	150 Volts*	150 Volts*	180 Volts*
2N5064	200 Volts*	200 Volts*	230 Volts*

- RMS On-State Current, $I_{T(RMS)}^{(4)}$ 0.8 Ampere*
- Peak One Cycle Surge (non-rep) On-State Current, I_{TSM} 6 Amperes*
- Peak Gate Power Dissipation, P_{GM} 5 Watts*
- Average Gate Power Dissipation, $P_{G(AV)}$ 0.01 Watt*
- Peak Forward Gate Current, I_{GM} 1 Ampere*
- Peak Reverse Gate Voltage, V_{GM} 5 Volts*
- Storage Temperature, T_{STG} $-65^\circ\text{C to } +150^\circ\text{C}$ *
- Operating Junction Temperature, T_J $-65^\circ\text{C to } +125^\circ\text{C}$ *

1 $R_{GK} = 1000$ ohms.
 2 Values apply for zero or negative gate voltage only.
 3 Half sine wave voltage pulse, 5 millisecond duration.
 4 Maximum Allowable Case Temperature is 67°C for half sine wave of current at 60 Hz.
 *Indicates JEDEC Registered Data.

2N5060
THRU
2N5064

CHARACTERISTICS

TEST	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Peak Reverse and Off-State Current (All Types)	I_{RRM} or I_{DRM}	—	—	1.0	μA	$T_C = +25^\circ C$, $R_{GK} = 1000$ ohms $V_{RRM} = V_{DRM} = \text{Rated Value}$.
		—	—	*50		$T_C = +125^\circ C$, $R_{GK} = 1000$ ohms $V_{RRM} = V_{DRM} = \text{Rated Value}$.
DC Gate Trigger Current	I_{GT}	—	—	200	μA_{dc}	$T_C = +25^\circ C$, $V_D = 7V_{dc}$, $R_L = 100$ ohms.
		—	—	*350		$T_C = -65^\circ C$, $V_D = 7V_{dc}$, $R_L = 100$ ohms.
DC Gate Trigger Voltage	V_{GT}	—	—	0.8	Vdc	$T_C = +25^\circ C$, $V_D = 7V_{dc}$, $R_L = 100$ ohms.
		—	—	*1.2		$T_C = -65^\circ C$, $V_D = 7V_{dc}$, $R_L = 100$ ohms.
		*0.1	—	—		$T_C = +125^\circ C$, Rated V_{DRM} , $R_L = 100$ ohms.
Peak On-State Voltage	V_{TM}	—	—	*1.7	V	$T_C = +25^\circ C$, $I_{TM} = 1.2A$ peak, 1 msec. wide pulse, Duty Cycle $\leq 2\%$
Holding Current	I_H	—	—	5.0	mA_{dc}	Anode source voltage = $7V_{dc}$, $R_{GK} = 1000$ ohms. $T_C = +25^\circ C$
		—	—	*10.0		$T_C = -65^\circ C$
Critical Rate-of-Rise of Off-State Voltage	dv/dt	—	20	—	V/ μsec	$T_C = +25^\circ C$, Rated V_{DRM} , $R_{GK} = 1000$ ohms.
Circuit Commutated Turn-Off Time	t_q	—	15	—	μsec	$T_C = +125^\circ C$, rectangular current waveform. Rate-of-rise of current $< 10A/\mu sec$. Rate reversal of current $< 5A/\mu sec$. $I_{TM} = 1A$ (50 μsec . pulse). Rep. Rate = 60 pps. $V_{RRM} = \text{Rated}$, $V_{RX} = 15V$ Min., $V_{DRM} = \text{Rated}$. Rate-of-rise of reapplied off-state voltage = $20V/\mu sec$.; Gate Bias = 0 Volts, 100 Ohms (during turn-off time interval).
Steady State Thermal Resistance	$R_{\theta JC}$	—	—	*75	$^\circ C/W$	Junction-to-case (flat side of case is temperature reference point).
	$R_{\theta JA}$	—	—	230		Junction-to-ambient (free convection).

*Indicates JEDEC Registered Data.